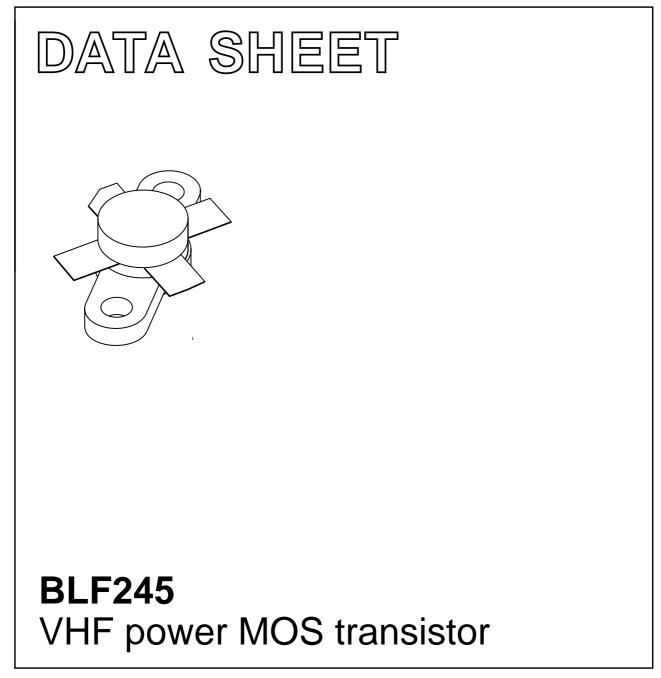
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1997 Dec 17 2003 Sep 02



BLF245

FEATURES

- High power gain
- Low noise figure
- · Easy power control
- Good thermal stability
- Withstands full load mismatch.

DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS transistor designed for large signal amplifier applications in the VHF frequency range.

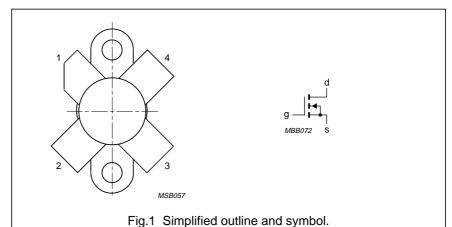
The transistor is encapsulated in a 4-lead SOT123A flange package, with a ceramic cap. All leads are isolated from the flange.

Matched gate-source voltage (V_{GS}) groups are available on request.

PINNING - SOT123A

| PIN | DESCRIPTION | | | | |
|-----|-------------|--|--|--|--|
| 1 | drain | | | | |
| 2 | source | | | | |
| 3 | gate | | | | |
| 4 | source | | | | |

PIN CONFIGURATION



CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A, and SNW-FQ-302B.

| WARNING |
|---|
| Product and environmental safety - toxic materials |
| This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste. |

QUICK REFERENCE DATA

RF performance at T_h = 25 $^\circ C$ in a class-B test circuit.

| MODE OF OPERATION | f | V _{DS} | P _L | G _p | η _D |
|-------------------|-------|-----------------|----------------|----------------|----------------|
| | (MHz) | (V) | (W) | (dB) | (%) |
| CW, class-B | 175 | 28 | 30 | >13 | >50 |

BLF245

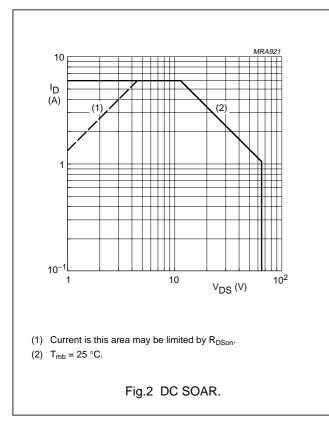
LIMITING VALUES

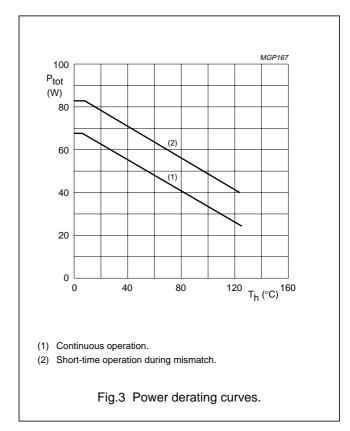
In accordance with the Absolute Maximum System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------|-----------------------------|------|------|------|
| V _{DS} | drain-source voltage | $V_{GS} = 0$ | _ | 65 | V |
| V _{GS} | gate-source voltage | $V_{DS} = 0$ | - | ±20 | V |
| I _D | drain current (DC) | | - | 6 | A |
| P _{tot} | total power dissipation | $T_{mb} \le 25 \ ^{\circ}C$ | _ | 68 | W |
| T _{stg} | storage temperature | | -65 | 150 | °C |
| Tj | junction temperature | | — | 200 | °C |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|---|-------|------|
| R _{th j-mb} | thermal resistance from junction to mounting base | $T_{mb} = 25 \ ^{\circ}C; P_{tot} = 68 \ W$ | 2.6 | K/W |
| R _{th mb-h} | thermal resistance from mounting base to heatsink | $T_{mb} = 25 \ ^{\circ}C; P_{tot} = 68 \ W$ | 0.3 | K/W |





Product specification

BLF245

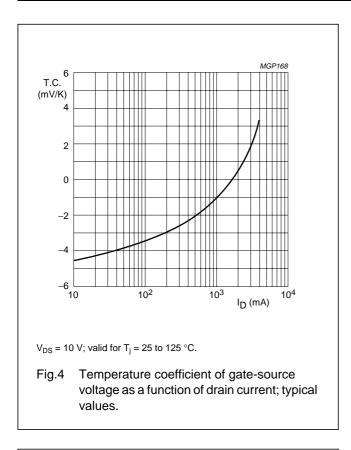
CHARACTERISTICS

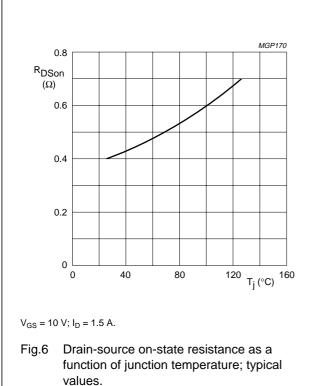
 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

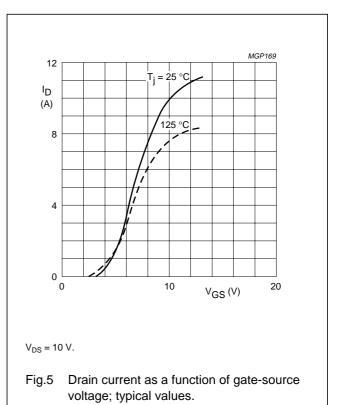
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------------|---|---|------|------|------|------|
| V _{(BR)DSS} | drain-source breakdown voltage | $V_{GS} = 0; I_D = 10 \text{ mA}$ | 65 | - | - | V |
| I _{DSS} | drain-source leakage current | $V_{GS} = 0; V_{DS} = 28 V$ | - | - | 2 | mA |
| I _{GSS} | gate-source leakage current | $V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$ | - | - | 1 | μA |
| V _{GSth} | gate-source threshold voltage | I _D = 10 mA; V _{DS} = 10 V | 2 | - | 4.5 | V |
| ΔV_{GS} | gate-source voltage difference of matched devices | | | - | 100 | mV |
| g _{fs} | forward transconductance | I _D = 1.5 A; V _{DS} = 10 V | 1.2 | 1.9 | - | S |
| R _{DSon} | drain-source on-state resistance | I _D = 1.5 A; V _{GS} = 10 V | - | 0.4 | 0.75 | Ω |
| I _{DSX} | on-state drain current | V _{GS} = 10 V; V _{DS} = 10 V | - | 10 | - | A |
| C _{is} | input capacitance | V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz | - | 125 | - | pF |
| C _{os} | output capacitance | V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz | - | 75 | - | pF |
| C _{rs} | feedback capacitance | V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz | - | 7 | - | pF |
| F | noise figure | input and output power matched for: $I_D = 1 \text{ A}$; $V_{DS} = 28 \text{ V}$; $P_L = 30 \text{ W}$; $R1 = 1 \text{ k}\Omega$; $T_h = 25 \text{ °C}$; $f = 175 \text{ MHz}$; see Fig.14 | _ | 2 | _ | dB |

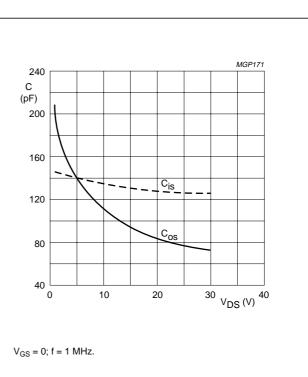
V_{GS} group indicator

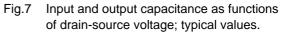
| GROUP | LIM (\ | ITS /) | GROUP | LIMITS (V) | | |
|-------|-----------|-----------|-------|---------------|------|--|
| | MIN. | MAX. | | MIN. | MAX. | |
| А | 2.0 | 2.1 | 0 | 3.3 | 3.4 | |
| В | 2.1 | 2.2 | Р | 3.4 | 3.5 | |
| С | 2.2 | 2.3 | Q | 3.5 | 3.6 | |
| D | 2.3 | 2.4 | R | 3.6 | 3.7 | |
| E | 2.4 | 2.5 | S | 3.7 | 3.8 | |
| F | 2.5 | 2.6 | Т | 3.8 | 3.9 | |
| G | 2.6 | 2.7 | U | 3.9 | 4.0 | |
| Н | 2.7 | 2.8 | V | 4.0 | 4.1 | |
| J | 2.8 | 2.9 | W | 4.1 | 4.2 | |
| K | 2.9 | 3.0 | Х | 4.2 | 4.3 | |
| L | 3.0 | 3.1 | Y | 4.3 | 4.4 | |
| М | 3.1 | 3.2 | Z | 4.4 | 4.5 | |
| N | 3.2 | 3.3 | | | | |



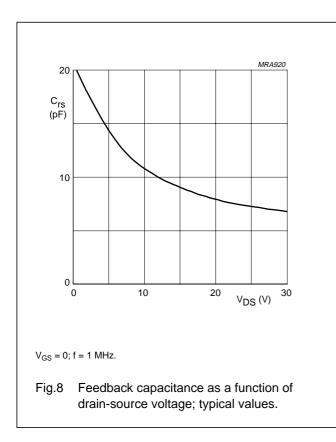








BLF245



APPLICATION INFORMATION FOR CLASS-B OPERATION

 $T_{h}=25~^{\circ}\text{C};~\text{R}_{th~mb\text{-}h}=0.3~\text{K/W};~\text{R1}=1~\text{k}\Omega.$

RF performance in CW operation in a common source class-B test circuit.

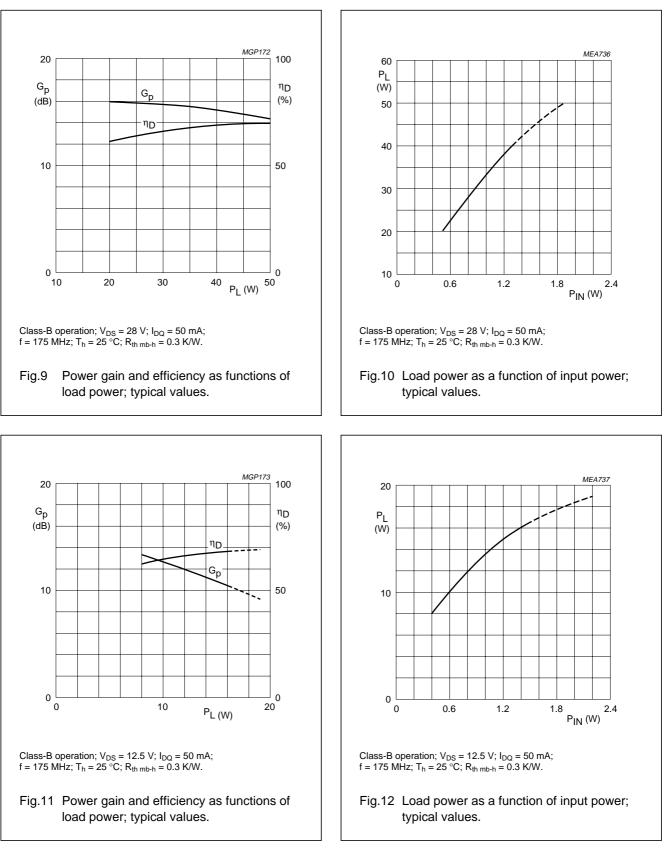
| MODE OF OPERATION | f (MHz) | V _{DS} (V) | I _{DQ} (mA) | P _L (W) | G _p (dB) | η _D (%) | Ζ _i (Ω) ⁽¹⁾ | Ζ L (Ω) |
|-------------------|------------|------------------------|-------------------------|-----------------------|------------------------|-----------------------|---|-------------------|
| CW, class-B | 175 | 28 | 50 | 30 | >13 typ. 15.5 | < 50 typ. 67 | 2.0 – j2.7 | 3.9 + j4.4 |
| | 175 | 12.5 | 50 | 12 | typ. 12 | typ. 66 | 2.4 – j2.5 | 3.8 + j1.3 |

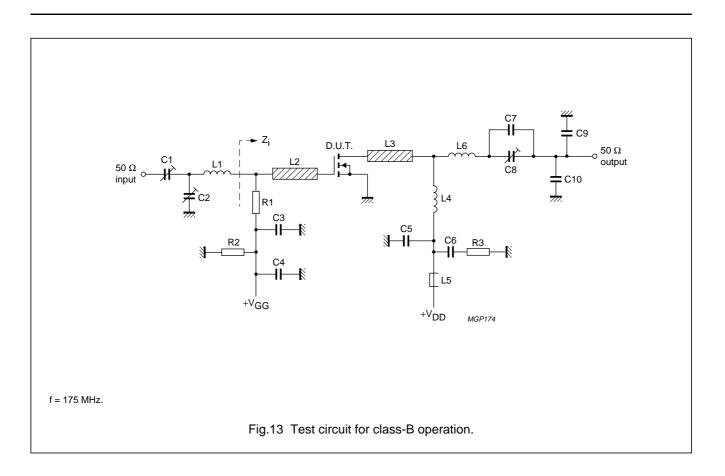
Note

1. R1 included.

Ruggedness in class-B operation

The BLF245 is capable of withstanding a load mismatch corresponding to VSWR = 50 through all phases under the following conditions: $T_h = 25$ °C; $R_{th mb-h} = 0.3$ K/W; at rated load power.





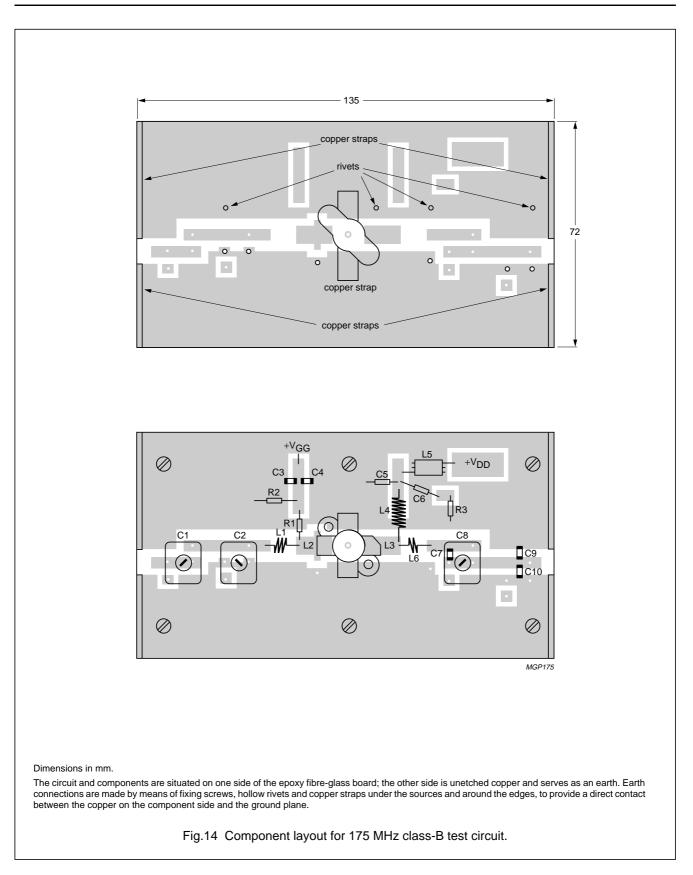
BLF245

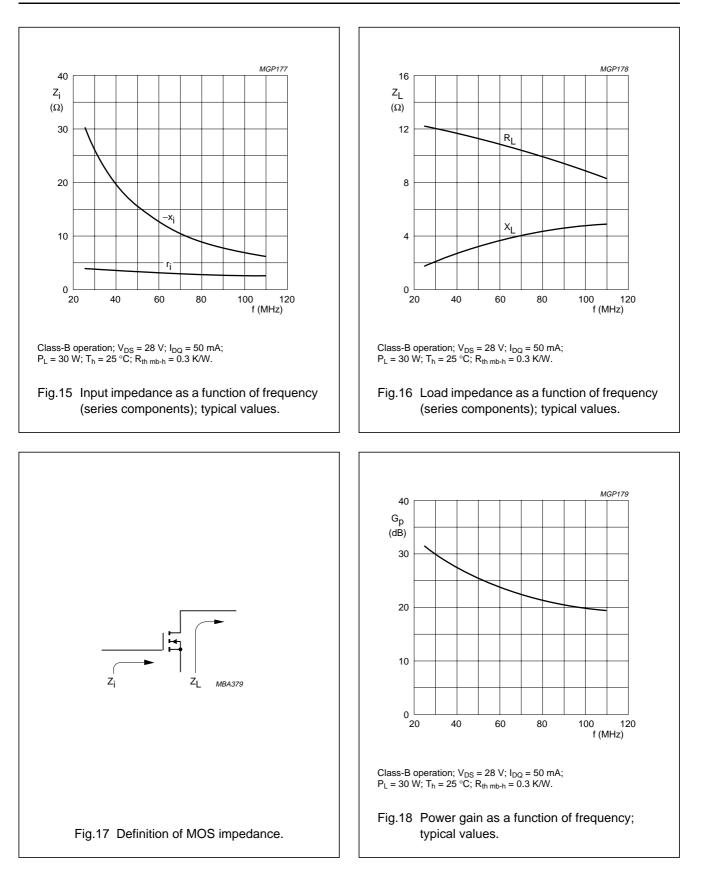
| COMPONENT | DESCRIPTION | VALUE | DIMENSIONS | CATALOGUE NO. |
|-----------|---|------------|---|----------------|
| C1 | film dielectric trimmer | 4 to 40 pF | | 2222 809 07008 |
| C2, C8 | film dielectric trimmer | 5 to 60 pF | | 2222 809 07011 |
| C3 | multilayer ceramic chip capacitor | 100 pF | | 2222 854 13101 |
| C4, C6 | multilayer ceramic chip capacitor | 100 nF | | 2222 852 47104 |
| C5 | ceramic capacitor | 100 pF | | 2222 680 10101 |
| C7 | multilayer ceramic chip capacitor; note 1 | 18 pF | | |
| C9 | multilayer ceramic chip capacitor; note 1 | 27 pF | | |
| C10 | multilayer ceramic chip capacitor; note 1 | 24 pF | | |
| L1 | 3 turns enamelled 0.5 mm copper wire | 13.5 nH | length 3.5 mm int. dia. 2 mm leads 2 × 2 mm | |
| L2, L3 | stripline; note 2 | 30 Ω | $10 \times 6 \text{ mm}$ | |
| L4 | 6 turns enamelled 1.5 mm copper wire | 98 nH | length 12.5 mm int. dia. 5 mm leads 2×2 mm | |
| L5 | grade 3B Ferroxcube RF choke | | | 4312 020 36640 |
| L6 | 2 turns enamelled 1.5 mm copper wire | 24.5 nH | length 4 mm int. dia. 5 mm leads 2 × 2 mm | |
| R1 | metal film resistor | 1 kΩ | | |
| R2 | metal film resistor | 1 MΩ | | |
| R3 | metal film resistor | 10 Ω | | |

List of components class-B test circuit (see Fig.14)

Notes

- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. The striplines are mounted on a double copper-clad PCB with epoxy fibre-glass dielectric (ϵ_r = 4.5), thickness $\frac{1}{16}$ inch.





BLF245

BLF245 scattering parameters

 V_{DS} = 12.5 V; I_{D} = 50 mA; note 1

| f (MHz) | s ₁₁ | | s ₂₁ | | S | 2 | \$ ₂₂ | | |
|---------|-----------------|---------------|-----------------|---------------|-----------------|---------------|------------------|---------------|--|
| | s ₁₁ | $\angle \Phi$ | s ₂₁ | $\angle \Phi$ | s ₁₂ | $\angle \Phi$ | s ₂₂ | $\angle \Phi$ | |
| 5 | 0.91 | -48.3 | 25.72 | 147.1 | 0.03 | 57.9 | 0.92 | -47.8 | |
| 10 | 0.80 | -81.4 | 19.43 | 125.8 | 0.05 | 36.8 | 0.81 | -81.3 | |
| 20 | 0.71 | -116.7 | 11.79 | 102.4 | 0.06 | 15.0 | 0.71 | -115.5 | |
| 30 | 0.68 | -132.3 | 8.04 | 89.7 | 0.06 | 3.3 | 0.69 | -131.1 | |
| 40 | 0.69 | -140.3 | 5.97 | 80.8 | 0.06 | -4.4 | 0.69 | -139.0 | |
| 50 | 0.71 | -145.2 | 4.67 | 73.6 | 0.06 | -10.2 | 0.71 | -143.8 | |
| 60 | 0.73 | -148.6 | 3.76 | 67.5 | 0.05 | -14.8 | 0.73 | -147.2 | |
| 70 | 0.75 | -151.1 | 3.10 | 62.4 | 0.05 | -18.4 | 0.75 | -149.9 | |
| 80 | 0.77 | -153.1 | 2.61 | 57.9 | 0.05 | -21.3 | 0.77 | -152.1 | |
| 90 | 0.79 | -155.1 | 2.24 | 53.7 | 0.04 | -23.8 | 0.79 | -154.2 | |
| 100 | 0.81 | -157.3 | 1.94 | 49.8 | 0.04 | -25.9 | 0.81 | -156.1 | |
| 125 | 0.84 | -161.9 | 1.39 | 41.2 | 0.03 | -28.0 | 0.85 | -160.1 | |
| 150 | 0.87 | -165.0 | 1.04 | 35.4 | 0.02 | -23.3 | 0.88 | -163.4 | |
| 175 | 0.91 | -167.9 | 0.81 | 30.8 | 0.01 | -8.4 | 0.91 | -166.3 | |
| 200 | 0.92 | -171.0 | 0.65 | 26.6 | 0.01 | 22.4 | 0.92 | -168.9 | |
| 250 | 0.94 | -175.5 | 0.44 | 21.6 | 0.02 | 72.1 | 0.95 | -173.3 | |
| 300 | 0.95 | -179.8 | 0.32 | 19.2 | 0.03 | 83.0 | 0.96 | -176.8 | |
| 350 | 0.96 | 176.9 | 0.24 | 19.7 | 0.04 | 86.1 | 0.97 | -179.8 | |
| 400 | 0.96 | 173.5 | 0.19 | 22.1 | 0.05 | 86.1 | 0.97 | 177.5 | |
| 450 | 0.97 | 170.6 | 0.16 | 26.1 | 0.06 | 86.2 | 0.97 | 174.9 | |
| 500 | 0.97 | 167.8 | 0.14 | 31.6 | 0.08 | 84.7 | 0.98 | 172.6 | |
| 600 | 0.96 | 162.4 | 0.13 | 43.5 | 0.10 | 82.6 | 0.98 | 168.4 | |
| 700 | 0.96 | 157.2 | 0.13 | 52.9 | 0.12 | 80.0 | 0.97 | 164.4 | |
| 800 | 0.94 | 152.4 | 0.14 | 58.9 | 0.13 | 77.9 | 0.97 | 160.6 | |
| 900 | 0.95 | 147.8 | 0.16 | 63.1 | 0.15 | 74.4 | 0.95 | 157.1 | |
| 1000 | 0.95 | 142.7 | 0.18 | 68.2 | 1.70 | 40.5 | 3.52 | 46.0 | |

Note

1. For more extensive s-parameters see internet:

http://www.semiconductors.philips.com/markets/communications/wirelesscommunication/broadcast

BLF245

BLF245 scattering parameters

 $V_{DS} = 28 \text{ V}; I_{D} = 50 \text{ mA}; \text{ note } 1$

| f (MHz) | s ₁₁ | | S ₁₁ S ₂₁ | | 21 | S | 2 | S ₂₂ | | |
|---------|-----------------|---------------|---------------------------------|---------------|-----------------|---------------|-----------------|-----------------|--|--|
| | s ₁₁ | $\angle \Phi$ | s ₂₁ | $\angle \Phi$ | s ₁₂ | $\angle \Phi$ | s ₂₂ | $\angle \Phi$ | | |
| 5 | 0.95 | -40.5 | 27.84 | 152.9 | 0.02 | 63.8 | 0.93 | -35.8 | | |
| 10 | 0.86 | -71.3 | 22.60 | 133.3 | 0.04 | 44.4 | 0.83 | -64.1 | | |
| 20 | 0.77 | -108.6 | 14.77 | 109.1 | 0.05 | 21.7 | 0.69 | -97.8 | | |
| 30 | 0.73 | -126.8 | 10.37 | 95.5 | 0.05 | 9.1 | 0.65 | -115.5 | | |
| 40 | 0.73 | -136.8 | 7.81 | 86.2 | 0.05 | 1.0 | 0.64 | -125.2 | | |
| 50 | 0.74 | -142.9 | 6.17 | 78.8 | 0.05 | -5.0 | 0.65 | -131.3 | | |
| 60 | 0.75 | -147.1 | 5.01 | 72.7 | 0.05 | -9.6 | 0.67 | -135.7 | | |
| 70 | 0.76 | -150.0 | 4.17 | 67.5 | 0.05 | -13.3 | 0.69 | -139.1 | | |
| 80 | 0.78 | -152.3 | 3.54 | 63.0 | 0.04 | -16.3 | 0.72 | -142.0 | | |
| 90 | 0.80 | -154.5 | 3.06 | 58.8 | 0.04 | -18.8 | 0.74 | -144.6 | | |
| 100 | 0.81 | -156.8 | 2.66 | 54.7 | 0.04 | -20.9 | 0.76 | -146.9 | | |
| 125 | 0.84 | -161.5 | 1.93 | 46.0 | 0.03 | -23.2 | 0.81 | -152.0 | | |
| 150 | 0.87 | -164.5 | 1.46 | 39.8 | 0.02 | -18.9 | 0.84 | -156.1 | | |
| 175 | 0.90 | -167.4 | 1.15 | 34.7 | 0.01 | -5.0 | 0.87 | -159.7 | | |
| 200 | 0.91 | -170.5 | 0.93 | 30.1 | 0.01 | 23.3 | 0.89 | -162.9 | | |
| 250 | 0.93 | -175.0 | 0.63 | 23.9 | 0.02 | 72.9 | 0.93 | -168.1 | | |
| 300 | 0.95 | -179.3 | 0.46 | 20.1 | 0.03 | 84.5 | 0.94 | -172.4 | | |
| 350 | 0.96 | 177.3 | 0.35 | 18.8 | 0.04 | 87.7 | 0.96 | -175.9 | | |
| 400 | 0.96 | 173.9 | 0.27 | 19.1 | 0.05 | 87.6 | 0.96 | -179.1 | | |
| 450 | 0.97 | 171.0 | 0.22 | 20.9 | 0.06 | 87.6 | 0.97 | 178.1 | | |
| 500 | 0.96 | 168.1 | 0.19 | 24.2 | 0.07 | 86.0 | 0.97 | 175.5 | | |
| 600 | 0.96 | 162.7 | 0.16 | 34.0 | 0.10 | 83.7 | 0.97 | 170.8 | | |
| 700 | 0.96 | 157.5 | 0.15 | 43.8 | 0.11 | 81.1 | 0.97 | 166.5 | | |
| 800 | 0.94 | 152.4 | 0.15 | 51.6 | 0.13 | 78.8 | 0.97 | 162.5 | | |
| 900 | 0.95 | 148.1 | 0.16 | 57.8 | 0.15 | 75.2 | 0.95 | 158.8 | | |
| 1000 | 0.95 | 142.9 | 0.18 | 64.3 | 1.92 | 53.7 | 4.01 | 59.9 | | |

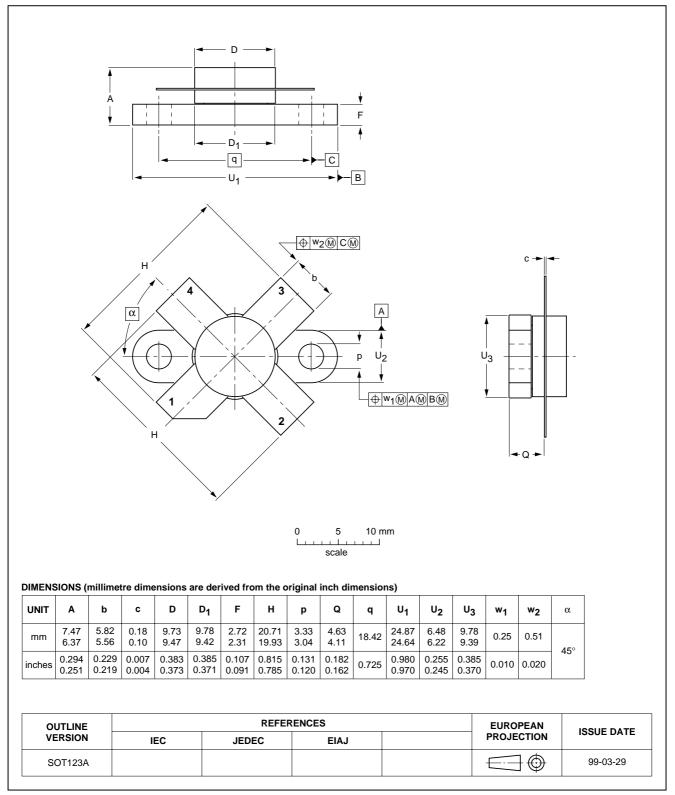
Note

1. For more extensive s-parameters see internet:

http://www.semiconductors.philips.co/.markets/communications/wirelesscommunication/broadcast

PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads



BLF245

SOT123A

Product specification

BLF245

DATA SHEET STATUS

| LEVEL | DATA SHEET STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾⁽³⁾ | DEFINITION |
|-------|-------------------------------------|-------------------------------------|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
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